# **Tyrone Camarero Specifications**

Camarero DS400TT-212RL Key features

HPC,Data Center, Enterprise Server,Finanical Analysis, Mission-critical applications
Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel® Xeon® Scalable Processors.
- a Intal CG21
- Up to 2TB 3DS ECC RDIMM, DDR4-2933MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-2933MHz, in 8 DIMM slots
- 1 PCI-E 3.0 x16 (LP) slot
- Dedicated IPMI 2.0 LAN
- 3 Hot-swap 3.5" SATA3 drive bays
- 2 SATA DOM + 1 SATA/NVMeM.2 (22110/2280)
- Up to 1600W Redundant Power Supplies Titanium Level (96%)







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Processor 2nd Generation Intel® Xeon® Scalable

Processors (Cascade Lake-SP), Intel®

Xeon® Scalable Processors.

### Chipset

Chipset Intel C621

**System Memory** 

Memory Capacity Up to 2TB 3DS ECC RDIMM,

DDR4-2933MHz;

Up to 2TB 3DS ECC LRDIMM, DDR4-2933MHz, in 8 DIMM slots

**Expansion Slots** 

PCI-Express 1 PCI-E 3.0 x16 Low-profile slot

## **Integrated On-Board**

SATA SATA3 (6Gbps); RAID 0, 1, 5 support

LAN 2 RJ45 Gigabit Ethernet LAN ports,

1 RJ45 Dedicated IPMI LAN port

**Add-on Options** 

Raid Card Optional

Optical Drive None

Front Panel

Leds Power status LED,HDD activity LED,Network

activity LEDs, Universal Information (UID) LED

Buttons Power On/Off button, UID button

**Drive Bays** 

HDD Bays 3 Hot-swap 3.5" SATA3 HDD tray

### **Power Supply**

1600W Redundant Power Supplies Titanium Level (96%)

### **Cooling System**

1 PCI-E 3.0 x16 Low-profile slot

#### **Form Factor**

Form Factor 2U Rackmount

Width 17.25" (438mm) Height 3.47" (88mm) Depth 28.5" (724mm)

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For more/current product information, visit

www.tyronesystems.com

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